

3.0V TO 4.2V. ISM BAND TRANSMIT/RECEIVE MODULE WITH DIVERSITY TRANSFER SWITCH

Package: LGA, 32-pin, 8mm x 8mm x 1.2mm



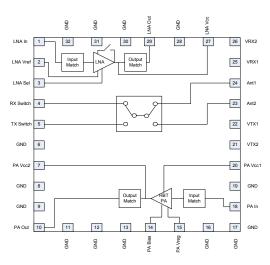
RFMD 🔊 **RFFM6904**

Features

- Integrated LNA, PA, and Transfer Switch
- Small Form Factor 8.0mm x 8.0mm x 1.2mm
- 50Ω Inputs and Outputs
- Low Insertion Loss, High Isolation Transfer Switch
- 33.5dBm PA Output Power
- Low PA Harmonic Content

Applications

- 868MHz/900MHz ISM Band Application
- Single Chip RF Front End Module
- Portable Battery Powered Equipment
- Wireless Automatic Metering Applications



Functional Block Diagram

Product Description

The RFFM6904 is a single-chip front-end module (FEM) for applications in the 868MHz/900MHz ISM Band. The RFFM6904 addresses the need for aggressive size reduction for typical portable equipment RF front-end design and greatly reduces the number of components outside of the core chipset thus minimizing the footprint and assembly cost of the overall solution. The RFFM6904 contains an integrated 2 Watt PA, TX/RX transfer switch, LNA with bypass mode, and matching components. The RFFM6904 is packaged in a 32-pin, 8.0mm x 8.0mm x 1.2mm overmolded laminate package with backside ground which greatly minimizes next level board space and allows for simplified integration.

Optimum Technology Matching® Applied				
🗹 GaAs HBT	SiGe BiCMOS	🗹 GaAs pHEMT	GaN HEMT	
GaAs MESFET	Si BiCMOS	Si CMOS	BIFET HBT	
InGaP HBT	SiGe HBT	🗌 Si BJT	LDMOS	

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Absolute Maximum Ratings

Parameter	Rating	Unit
Overall		
DC Supply Voltage	+5.0	V
Operating Ambient Temperature	-40 to +85	°C
Storage Temperature	-40 to +150	°C
Low Noise Amplifier		
DC Supply Current	32	mA
Input RF Power	5	dBm
Power Amplifier		
DC Supply Current	1200	mA
Input RF Power	10	dBm
Transmit/Receive Switch		
Input RF Power	33	dBm



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

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RoHS (Restriction of Hazardous Substances): Compliant per EU Directive 2002/95/EC.

Deveneter	Specification		11	O a u diti a u		
Parameter	Min.	Тур.	Max.	Unit	Condition	
Low Noise Amplifier						
Frequency Range	868	902 to 928		MHz		
High Gain Mode					Gain Select < 0.8V	
Gain	17	21	23.5	dB	Over LNA $\rm V_{CC}$, LNA $\rm V_{REF}$ Temperature, and Frequency	
Noise Figure		1.3	1.5	dB	$LNAV_{REF} = LNAV_{CC} = 3.3V$	
Input IP3	-4.5	-1		dBm	T _{AMB} = +25 °C, LNA V _{CC} = 3.3V	
Input Gain Compression	-15			dBm		
Input Return Loss		-8	-5	dB		
Output Return Loss		-8	-6	dB		
LNA Operating Current			15	mA	$LNAV_{REF} = LNAV_{CC} = 3.3V$	
LNA Enable			1	mA		
Stability, Input VSWR	10:1				All phase angles	
Output Spurious			-70	dBc		
Low Gain Mode					Gain Select > 1.8V	
Gain	-7	-6		dB		
Input IP3	15.5	17		dBm	T _{AMB} = +25 °C, LNA V _{CC} = 3.3V	
Current Drain		1.5	3	mA		
Power Amplifier						
Frequency Range	868	902 to 928		MHz		
PA V _{CC1} = PA V _{CC2} = PA BIAS	3.2	4.0	4.5	V		
PA V _{REG}	2.75	2.85	2.95	V		
P _{OUT}	32.5	33.5		dBm	Saturated power output	
Gain	27	30		dB	PA V_{CC1} = PA V_{CC2} = PA BIAS = 4V, over temperature and frequency	
Output Harmonic Levels						
2nd			-42.5	dBc		
3rd through 10th			-72.5	dBc	PA V_{CC1} = PA V_{CC2} = PA BIAS = 4V, over temperature and frequency	



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Specification Parameter Unit Condition Min. Тур. Max. Power Amplifier, cont. Efficiency 40 % 33.5dBm output, PA V_{CC1} = PA V_{CC2} = PA BIAS = 4.0V, 2.85V V_{REG} Input Return Loss 9 dB **Output Spurious** -70 dBc Stability 10:1 All phase angles All phase angles, -40°C 7:1 Current 750 1000 33.5dBm output, PA V_{CC1} = PA V_{CC2} = PA BIAS Operating mΑ = 4.0V, 2.85V V_{REG} **Bias Only** 200 mΑ Idle current, no RF at input 2 6 mΑ IREG 0.1 0.9 Leakage Current μΑ Over V_{CC}, Frequency, and Temperature Transmit/Receive Switch 868 MHz Frequency Range 902 to 928 Insertion Loss TX to ANT1 or ANT2 0.85 1.4 dB RX to ANT1 or ANT2 0.95 1.4 dB Any Path (1800MHz to 2 dB 1860MHz) Any Path (2700MHz to 2 dB 2790MHz) Any Path (>3600MHz) 15 dB 18 Isolation (All Paths) dB Input IP3 55 dBm Thermal Resistance 47.8 °C/W $4V V_{CC}$, 2.85V V_{REG} , 31dBm P_{OUT} , T_{REF} = 85 °C **Output Harmonic Levels** 2nd -60 dBc -80 3rd through 10th dBc Input 1dB Gain Compression 30 32 dBm Return Loss (All Ports) 18 dB Active ports only Switch Control Logic HIGH 2.6 3.5 V Switch Control Logic LOW ٧ 0 0.2 Switch Control Current 5 μΑ VTX2, VRX1, and VRX2 40 VTX1 μΑ Transition Time 2 μΑ Settle to 0.25dB of final value

Connected Path	RX SW to ANT1	RX SW to ANT2	TX SW to ANT1	TX SW to ANT2
VRX1	High	Low	Low	Low
VRX2	Low	High	Low	Low
VTX1	Low	Low	High	Low
VTX2	Low	Low	Low	High

*Switch Control Logic High = Min 2.6V to Max 3.5V

*Switch Control Logic Low = Min 0.0V to Max 0.2V

RFFM6904

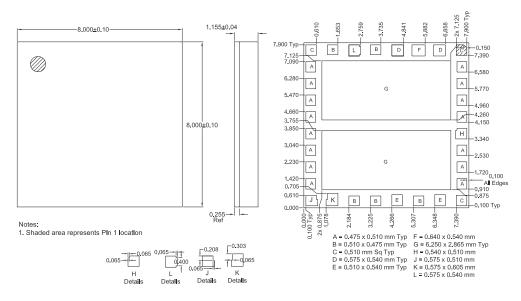


Pin Names and Description

Pin	Name	Description	
1	LNA IN	RF Input to the low noise amplifier, 50Ω nominal impedance.	
2	LNA VREF	Voltage to set the bias level to the LNA, 3.0V nominal, can be used to shut the LNA off or to adjust the qui- escent current.	
3	LNA SELECT	A logic low selects the high gain mode of the LNA, logic high selects the low gain mode.	
4	RX SWITCH INPUT	RF port from the Switch going to the LNA input, 50 $\!\Omega$ nominal impedance.	
5	TX SWITCH INPUT	RF port from the Switch going to the PA output, 50Ω nominal impedance.	
6	GND	Ground.	
7	PA VCC2	Voltage supply for the Power Amplifier, nominal voltage is 3.6V.	
8	GND	Ground.	
9	GND	Ground.	
10	PA OUT	RF output from the Power Amplifier, 50 $\!\Omega$ nominal impedance and DC blocked.	
11	GND	Ground.	
12	GND	Ground.	
13	GND	Ground.	
14	PA BIAS	Voltage supply for the Power Amplifier bias network, nominal voltage is 3.6V.	
15	PA VREG	Voltage to set the bias level of the Power Amplifier, nominal voltage is 2.85V.	
16	GND	Ground.	
17	GND	Ground.	
18	PA IN	RF Input to the Power Amplifier, 50 $\!\Omega$ nominal impedance.	
19	GND	Ground.	
20	PA VCC1	Voltage supply for the Power Amplifier, nominal voltage is 3.6V.	
21	VTX2	Logic input to the Switch, see Logic Table below.	
22	VTX1	Logic input to the Switch, see Logic Table below.	
23	ANT2	RF port from the Switch going to Antenna 1, 50 Ω nominal impedance.	
24	ANT1	RF port from the Switch going to Antenna 2, 50 Ω nominal impedance.	
25	VRX1	Logic input to the Switch, see Logic Table below.	
26	VRX2	Logic input to the Switch, see Logic Table below.	
27	LNA VCC	LNA Collector Voltage, nominal voltage is 3.0V.	
28	GND	Ground.	
29	LNA OUT	RF Output from the low noise amplifier, 50 $\!\Omega$ nominal impedance and DC blocked.	
30	GND	Ground.	
31	GND	Ground.	
32	GND	Ground.	
Pkg Base	GND	The central metal base of package provides DC and RF GND as well as heat sink for the amplifier.	



Package Drawing

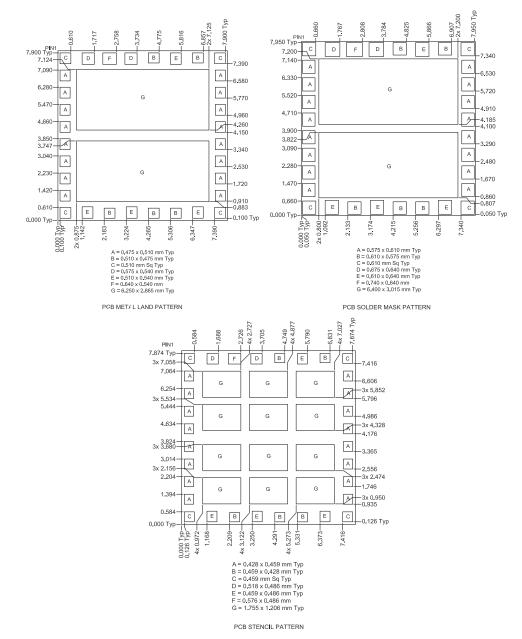


All units in μ m. Pin A = 510 x 475 Pin B = 510 x 510 Pin C = 475 x 510



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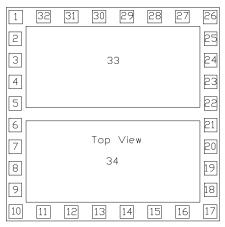
PCB Patterns



Thermal vias for center slug "G" should be incorporated into the PCB design. The number and size of thermal vias will depend on the application. Example of the number and size of vias can be found on the RFMD evaluation board layout.



Pin Out





Application Schematic

